IGBT - Field Stop 600 V, 20 A

FGH20N60UFD

Description

Using novel field stop IGBT Technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ I_C = 20 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, PFC

ABSOLUTE MAXIMUM RATINGS

Symbol	Value	Unit
V _{CES}	600	V
V _{GES}	±20	V
	±30	
Ι _C	40 20	A
I _{CM} (Note 1)	60	A
IF	20 10	A
I _{FM} (Note 1)	60	A
PD	165 66	W
TJ	–55 to + 150	°C
T _{stg}	–55 to + 150	°C
TL	300	°C
	V _{CES} V _{GES} I _C I _C (Note 1) I _F (Note 1) P _D T _J T _{stg}	$\begin{tabular}{ c c c c } \hline V_{CES} & 600 \\ \hline V_{GES} & \pm 20 \\ \hline & \pm 30 \\ \hline & & & & & \\ \hline & & & & & \\ \hline & & & &$

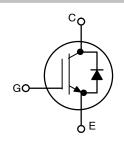
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

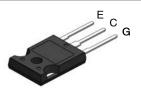
1. Repetitive rating: Pulse width limited by max. junction temperature.



ON Semiconductor®

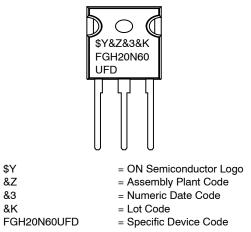
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TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур.	Max.	Unit
Thermal Resistance Junction-to-Case, for IGBT	$R_{ ext{ heta}JC}$	-	0.76	°C/W
Thermal Resistance Junction-to-Case, for Diode	$R_{ ext{ heta}JC}$	-	2.51	°C/W
Thermal Resistance Junction-to-Ambient	$R_{ hetaJA}$	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH20N60UFDTU	FGH20N60UFD	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	V_{GE} = 0 V, I _C = 250 µA	-	0.6	-	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	$I_C = 250 \ \mu\text{A}, \ V_{CE} = V_{GE}$	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 20 A, V _{GE} = 15 V	-	1.8	2.4	V
		I_{C} = 20 A, V_{GE} = 15 V, T_{C} = 125°C	_	2.0	-	V
DYNAMIC CHARACTERISTICS		•			•	
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	940	-	pF
Output Capacitance	C _{oes}	1	-	110	-	pF
Reverse Transfer Capacitance	C _{res}	1	-	40	-	pF
SWITCHING CHARACTERISTICS		•			•	
Turn-On Delay Time	t _{d(on)}	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 20 \text{ A},$	-	13	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	17	-	ns
Turn-Off Delay Time	t _{d(off)}	1	_	87	-	ns
Fall Time	t _f	1	-	32	64	ns
Turn-On Switching Loss	E _{on}	1	-	0.38	-	mJ
Turn-Off Switching Loss	E _{off}	1	-	0.26	-	mJ
Total Switching Loss	E _{ts}	1	-	0.64	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A},$	-	13	-	ns
Rise Time	t _r	$R_G = 10 \Omega, V_{GE} = 15 V,$ Inductive Load, $T_C = 125^{\circ}C$	_	16	-	ns
Turn–Off Delay Time	t _{d(off)}		_	92	-	ns
Fall Time	t _f		_	63	-	ns
Turn–On Switching Loss	E _{on}		-	0.41	-	mJ
Turn–Off Switching Loss	E _{off}		-	0.36	-	mJ
Total Switching Loss	E _{ts}		-	0.77	-	mJ
Total Gate Charge	Qg	V _{CE} = 400 V, I _C = 20 A, V _{GE} = 15 V	-	63	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	7	-	nC
Gate to Collector Charge	Q _{gc}	1	_	32	_	nC

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	l _F = 10 A	T _C = 25°C	-	1.9	2.5	V
			T _C = 125°C	-	1.7	-	
Diode Reverse Recovery Time	t _{rr}	l _F = 10 A, di _F /dt = 200 A/μs	T _C = 25°C	-	34	-	ns
			T _C = 125°C	-	57	-	
Diode Reverse Recovery Charge	Q _{rr}		T _C = 25°C	-	41	-	nC
			T _C = 125°C	-	96	-]

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

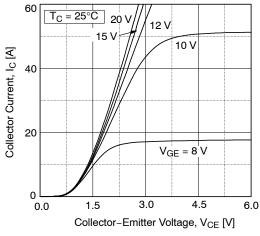
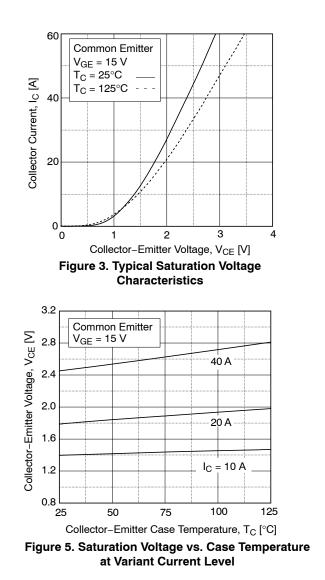
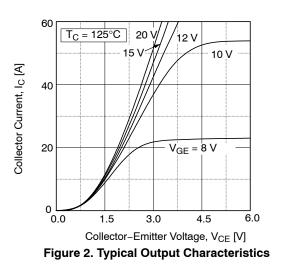
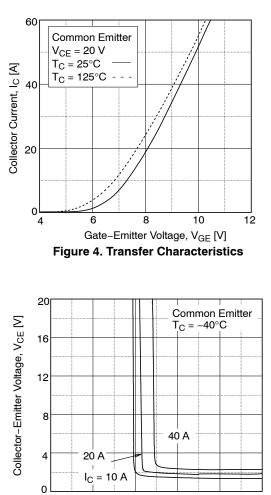
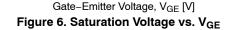


Figure 1. Typical Output Characteristics

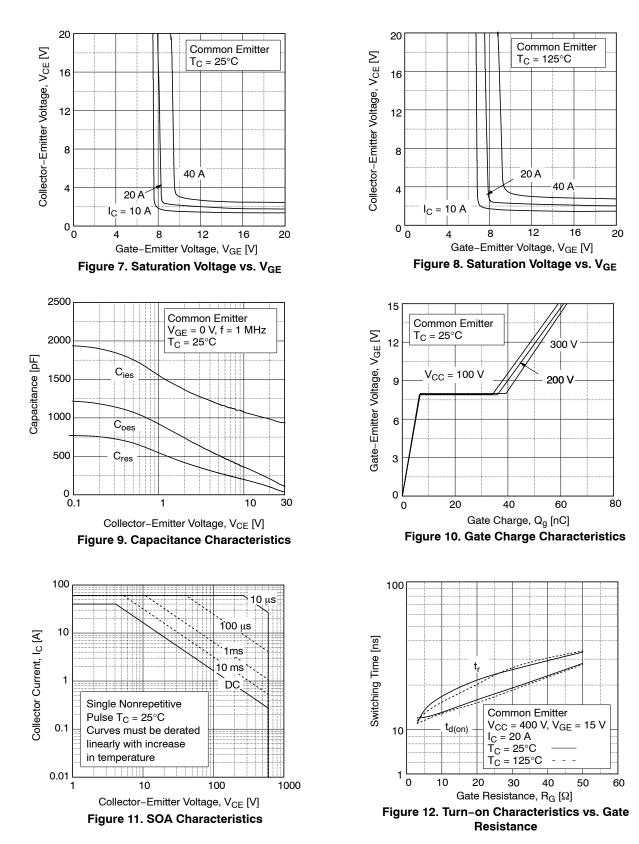




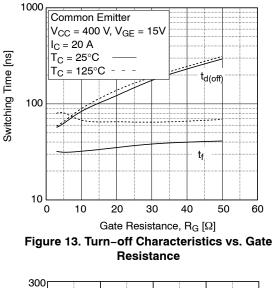




TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



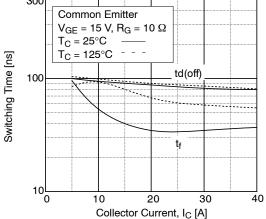


Figure 15. Turn-off Characteristics vs. Collector Current

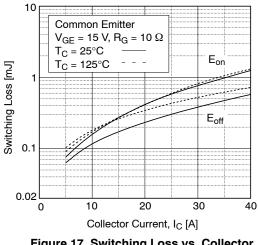
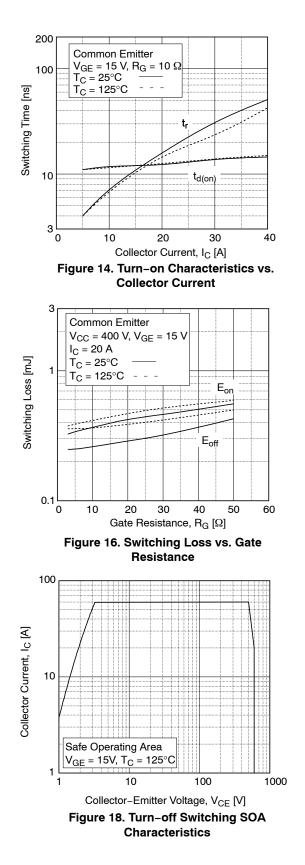
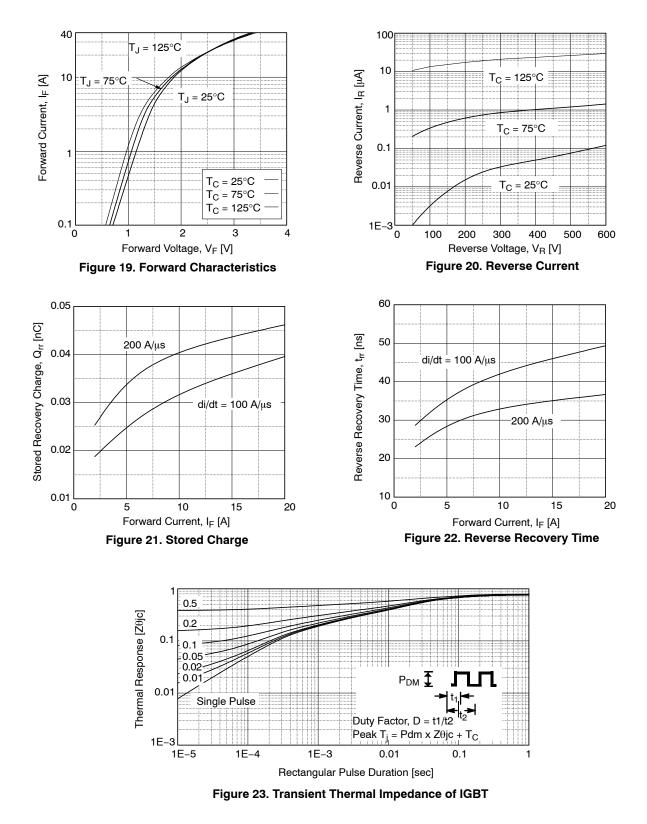


Figure 17. Switching Loss vs. Collector Current



TYPICAL CHARACTERISTICS







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